



DISCRIPTION

FEATURES

Ceramic Core High frequency design Excellent Q values Excellent SRF High reliability Excellent thermal stability

OPTIONS

Tape & Reel is Standard (Qty: 3.000 Pcs) Bulk Packing Available for smaller quantites Tolerance: J = 5% and K=10% is Standard, tighter Tolerance available (MOQ on request)

APPLICATIONS

Modems Mobile Radios Cordless Telephones Global Positioning Systems Telecommunications Systems

PHYSICAL CHARACTERISTICS

- Testing : (Equivalents acceptable) Inductance & Q-HP4191A + HP4291A SRF : HP8553B ; RDC : 25°C
- Operating Temperature : Ceramic -55°C ~ 125°C
- Pad metalization : Tungsten-nickel with gold flash
- Solder methods : Wave, Reflow, Vapor Phase
- Solderability : Max 260°C for 10 seconds
- Marking : EIA color code

ELECTRICAL SPECIFICATIONS

| Properties | Test conditions | | Value | Unit | Tol. |
|--------------------|-----------------|----------|-------|------|------------|
| Inductance | | L | 8,2 | nH | see Site 2 |
| Q factor | | Q | 50 | | min. |
| DC-resistance | | DCR typ. | | Ω | typ. |
| DC-resistance | | DCR max. | 0,050 | Ω | max. |
| Self-Res. Freq. | | SRF | 5000 | Mhz | min. |
| Test-Freq. | | | 1000 | Mhz | |
| Rated Current | | IDC | 1000 | mA | max. |
| Saturation Current | | Isat | | mA | typ. |

| . This electronic component is meant to be used in general electronic equipment. Before the incorporation of this component into any equipment with higher and more reliable requirements such as aviation, aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medica bublic information network, etc. or if there is a possibility of injuries or damages to the human body, Edco | | | | | h as aviation, vention, medical, | CERAI | T WIRE-WOUND ERAMIC CHIP INDUCTORS | | |
|--|-------|------|-------|--------|-------------------------------------|-----------|--|------------|--|
| -Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability | | | | | | Part No.: | S12004-8N2 | | |
| functions. | | | | | | Customer: | | | |
| DRW: | Chang | CHKD | Young | MATL: | Chu Chi | DATE | | 09.06.2009 | |
| APPD: | Pong | | | FINISH | Vienna | Sheet | | 1 from 2 | |

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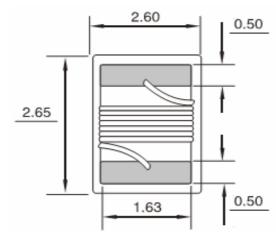
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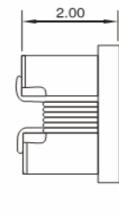


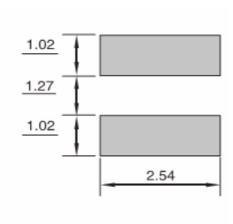


TECHNICAL INFORMATIONS

Dimensions (mm)



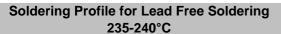


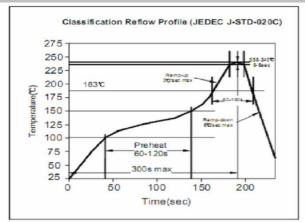


Ordering Information

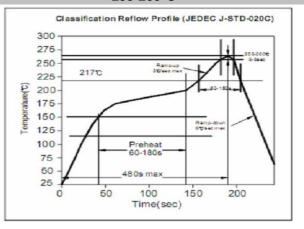
Serie and Range S12004-8N2

| Tolerance | ROHS | Packing | | | |
|----------------|-----------------|-----------------------|--|--|--|
| К | R | TR | | | |
| | | | | | |
| J = 5% | R = ROHS | BU = Bulk Ware | | | |
| K = 10% | N = non ROHS | TR = Tape Reel | | | |
| M = 20% | | | | | |
| N = 30% | | | | | |





Soldering Profile for Lead Free Soldering 255-260°C



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|---|-------|------|-------|--------|------------------------------|---|---|------------|--|
| -Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability | | | | | Part No.: \$12004-8N2 | | | | |
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